

C0402C439C5GACTU

Aliases (C0402C439C5GAC7867)

SMD Comm COG, Ceramic, 4.3 pF, +/-0.25 pF, 50 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 0402



Click [here](#) for the 3D model.

Dimensions

| | |
|-----------|-----------------|
| Chip Size | 0402 |
| L | 1mm +/-0.05mm |
| W | 0.5mm +/-0.05mm |
| T | 0.5mm +/-0.05mm |
| S | 0.3mm MIN |
| B | 0.3mm +/-0.1mm |

Packaging Specifications

| | |
|--------------------|------------------------|
| Packaging | T&R, 180mm, Paper Tape |
| Packaging Quantity | 10000 |

General Information

| | |
|------------------|--|
| Series | SMD Comm COG |
| Style | SMD Chip |
| Description | SMD, MLCC, Ultra-Stable, Low Loss, Class I |
| Features | Ultra-Stable, Low Loss, Class I |
| RoHS | Yes |
| Termination | Tin |
| Marking | No |
| AEC-Q200 | No |
| Component Weight | 1.06 mg |
| Shelf Life | 78 Weeks |
| MSL | 1 |

Specifications

| | |
|--|------------------------|
| Capacitance | 4.3 pF |
| Measurement Condition | 1 MHz 1.0Vrms |
| Capacitance Tolerance | +/-0.25 pF |
| Voltage DC | 50 VDC |
| Dielectric Withstanding Voltage | 125 VDC |
| Temperature Range | -55/+125°C |
| Temperature Coefficient | COG |
| Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC) | 30 ppm/C, 1MHz 1.0Vrms |
| Dissipation Factor | 0.1% 1 MHz 1.0Vrms |
| Aging Rate | 0% Loss/Decade Hour |
| Insulation Resistance | 100 GOhms |